### Shielded Power Inductors – XFL4012

![Inductor Image](image)

- High current ratings and low DCR
- Very low profile, only 1.2 mm high

**Designer’s Kit C455** contains 5 of each XFL4012 and XFL4015 value.

**Core material** Composite

- **Weight** 85 – 95 mg
- **Operating voltage** 0 – 20 V
- **Environmental** RoHS compliant, halogen free

**Terminations** RoHS compliant tin-silver (96.5/3.5) over copper. Other terminations available at additional cost.

- **Ambient temperature** –40°C to +125°C with (40°C rise) Irms current.
- **Maximum part temperature** +165°C (ambient + temp rise). Derating.
- **Storage temperature** Component: –55°C to +165°C. Tape and reel packaging: –55°C to +80°C

**Resistance to soldering heat** Max three 40 second reflows at +260°C, parts cooled to room temperature between cycles

- **Moisture Sensitivity Level (MSL)** 1 (unlimited floor life at <30°C / 85% relative humidity)

**Failures in Time (FIT) / Mean Time Between Failures (MTBF)**

- 0.48 per billion hours / 2.08E+09 hours, calculated per Telcordia SR-332
- **PCB washing** Tested to MIL-STD-202 Method 215 plus an additional aqueous wash. See [Doc787_PCB_Washing.pdf](#).

### Specifications

<table>
<thead>
<tr>
<th>Part number</th>
<th>Inductance (±20% (µH))</th>
<th>DCR (mOhms)</th>
<th>SRF (MHz)</th>
<th>Isat (A)</th>
<th>Irms (A)</th>
</tr>
</thead>
<tbody>
<tr>
<td>XFL4012-121ME</td>
<td>0.12</td>
<td>5.20</td>
<td>5.88</td>
<td>220</td>
<td>6.9</td>
</tr>
<tr>
<td>XFL4012-251ME</td>
<td>0.25</td>
<td>7.64</td>
<td>8.40</td>
<td>150</td>
<td>4.4</td>
</tr>
<tr>
<td>XFL4012-471ME</td>
<td>0.47</td>
<td>14.07</td>
<td>15.48</td>
<td>115</td>
<td>3.2</td>
</tr>
<tr>
<td>XFL4012-601ME</td>
<td>0.60</td>
<td>17.40</td>
<td>19.14</td>
<td>95.0</td>
<td>2.8</td>
</tr>
</tbody>
</table>

1. When ordering, please specify termination and packaging codes:

   **Termination:**
   - **E** = RoHS compliant tin-silver over copper.
   - **T** = RoHS tin-silver-copper (96.5/3.5/0.5)
   - **S** = non-RoHS tin-lead (63/37).

   **Packaging:**
   - **C** = 7” machine-ready reel. EIA-481 embossed plastic tape (1500 parts per full reel). Quantities less than full reel available: in tape (not machine ready) or with leader and trailer ($25 charge).
   - **B** = Less than full reel. In an effort to simplify our part numbering system, Coilcraft is eliminating the need for multiple packaging codes. When ordering, simply change the last letter of your part number from B to C.
   - **D** = 13” machine-ready reel. EIA-481 embossed plastic tape. Factory order only, not stocked (5000 parts per full reel).

2. Inductance tested at 1 MHz, 0.1 Vrms, 0 Adc.
3. DCR measured on a micro-ohmmeter.
4. SRF measured using Agilent/HP 4395A or equivalent.
5. DC current at 25°C that causes the specified inductance drop from its value without current. **Click for temperature derating information.**
6. Current that causes the specified temperature rise from 25°C ambient. This information is for reference only and does not represent absolute maximum ratings. **Click for temperature derating information.**
7. Electrical specifications at 25°C.

Refer to Doc 362 “Soldering Surface Mount Components” before soldering.

### Irms Testing

Irms testing was performed on 0.75 inch wide × 0.25 inch thick copper traces in still air.

Temperature rise is highly dependent on many factors including pcb land pattern, trace size, and proximity to other components. Therefore temperature rise should be verified in application conditions.

**Click for temperature derating information.**

**Environmental**

- **Operating voltage** 0 – 20 V

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L vs Current

- 0.12 µH
- 0.25 µH
- 0.47 µH
- 0.60 µH

L vs Frequency

- 0.12 µH
- 0.25 µH
- 0.47 µH
- 0.60 µH

Dash thickness (typ)

Terminal number (in / mm)

- 0.0023 / 0.06
- 0.0032 / 0.08
- 0.0032 / 0.08
- 0.0023 / 0.06

Dash number

Indicates direction of terminals and start (short) lead. Connect high dv/dt here for lowest EMI.

Recommended Land Pattern

Packaging

- 1500/7” reel
- 5000/13” reel

Plastic tape: 12 mm wide, 0.23 mm thick, 8 mm pocket spacing, 1.40 mm pocket depth

Dimensions are in inches / mm

* For optional tin-lead and tin-silver-copper terminations, dimensions are for the mounted part. Dimensions before mounting can be an additional 0.005 inch / 0.13 mm.